

LS5018B LS5060B/LS5120B

 $\mathsf{TRISIL}^\mathsf{TM}$

FEATURES

- BIDIRECTIONAL CROWBAR PROTECTION.
- BREAKDOWN VOLTAGES RANGE: 18V, 60V and 120V.
- HOLDING CURRENT = 200mA min.
- HIGH SURGE CURRENT CAPABILITY IPP = 100A 10/1000 μs

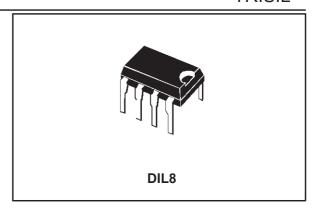
DESCRIPTION

The LS50xxB series has been designed to protect telecommunication equipment against lightning and transients induced by AC power lines. Its high surge current capability makes the

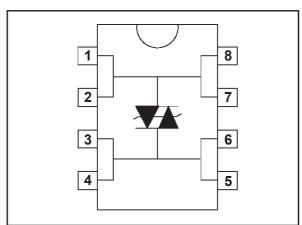
Its high surge current capability makes the LS50xxB a reliable protection device for very exposed equipment, or when series resistors are very low.

COMPLIES WITH THE FOLLOWING STANDARDS:

CCITT K17 - K20	10/700	μs	1.5 kV
	5/310	μs	38 A
VDE 0433	10/700	μs	2 kV
	5/200	μs	50 A
CNET	0.5/700	μs	1.5 kV
	0.2/310	μs	38 A



SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS (Tamb =25°C)

Symbol	Parameter	Value	Unit	
lpp	Peak pulse current 10/1000 μs 8/20 μs		100 250	А
ITSM	Non repetitive surge peak on-state tp = 20 ms current		50	А
dI/dt	Critical rate of rise of on-state current Non repetitive		100	A/μs
dV/dt	Critical rate of rise of off-state voltage V _{RM}		5	kV/μs
T _{stg} T _j	Storage and operating junction temperat	- 40 to + 150 150	°C °C	
TL	Maximum lead temperature for soldering	230	°C	

September 1998 Ed: 3A

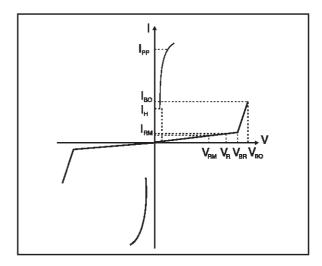
LS5018B/LS5060B/LS5120B

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th} (j-a)	Junction to ambient on printed circuit with recommended pad layout	80	°C/W

ELECTRICAL CHARACTERISTICS (T_{amb} =25°C)

Symbol	Parameter			
I _{RM}	Leakage current at stand-offvoltage			
V _{RM}	Stand-offvoltage			
V_{BR}	Breakdownvoltage			
V _{BO}	Breakovervoltage			
Ін	Holding current			
I _{BO}	Breakover current			
IPP	Peak pulse current			
С	Capacitance			

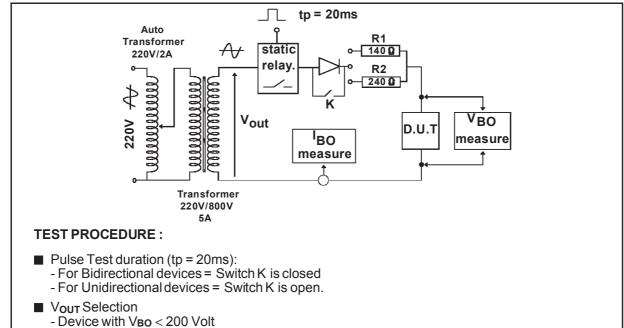


	I _{RM} @ V _{RM}		V _{BR} @ I _R		V _{BO} @ I _{BO}		lμ	С
Type	max.		min.		max.	typ.	min.	max.
,.					note 1		note 2	note 3
	μ Α	٧	٧	mA	V	mA	mA	pF
LS5018B	5	16	17	1	22	1300	200	150
LS5060B	10	50	60	1	85	1000	200	150
LS5120B	20	100	120	1	180	1250	250	150

Note 1 : Measured at 50Hz (1 cycle) Note 2 : See test circuit Note 3 : $V_R = 5 V$, F = 1 MHz.

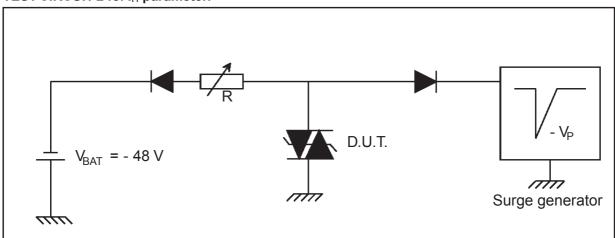
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TEST CIRCUIT 1 FOR IBO and VBO parameters:



TEST CIRCUIT 2 for I_H parameter.

- Device with V_{BO} ≥ 200 Volt



This is a GO-NOGO Test which allows to confirm the holding current (I_H) level in a functional test circuit.

TEST PROCEDURE:

- 1) Adjust the current level at the I_H value by short circuiting the AK of the D.U.T.
 - 2) Fire the D.U.T with a surge Current : Ipp = 10A, $10/1000 \,\mu s$.
 - 3) The D.U.T will come back off-state within 50 ms max.

- Vout = 250 V_{RMS}, R_1 = 140 Ω .

- Vout = 480 V_{RMS}, R_2 = 240 Ω .

Figure 1 : Non repetitive surge peak current versus overload duration

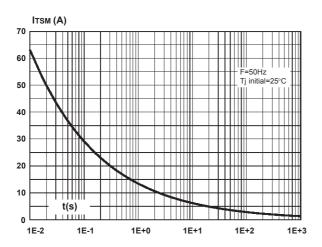


Figure 3: Relative variation of breakdown voltage versus ambient temperature.

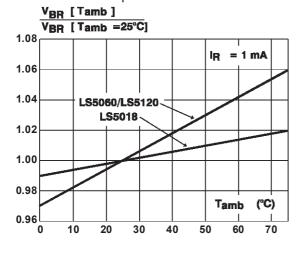


Figure 2: Relative variation of holding current versus junction temperature.

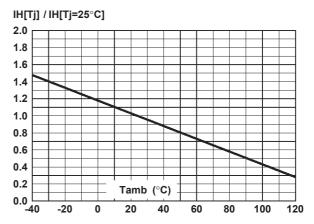
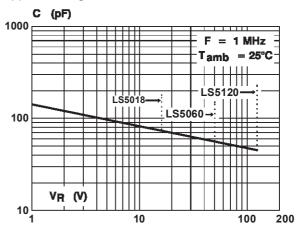
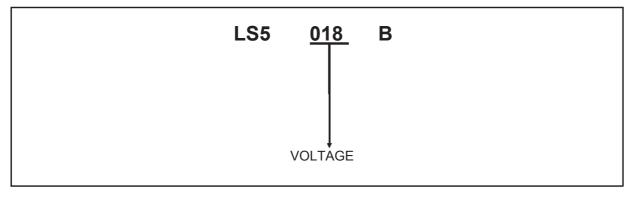


Figure 4: Junction capacitance versus reverse applied voltage.



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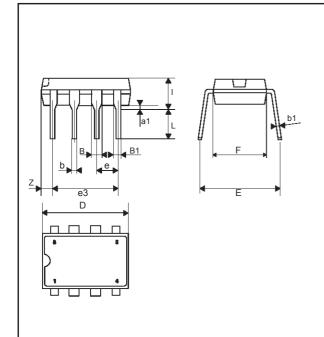
MARKING: Logo, Date Code, part Number.

Packaging: Products supplied in antistatic tubes.

Weight: 0.59g

PACKAGE MECHANICAL DATA

DIL 8 Plastic



	DIMENSIONS						
REF.	Millimetres			;			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
a1	0.70			0.027			
В	1.39		1.65	0.055		0.065	
B1	0.91		1.04	0.036		0.041	
b		0.5			0.020		
b1	0.38		0.50	0.015		0.020	
D			9.80			0.385	
E		8.8			0.346		
е		2.54			0.100		
e3		7.62			0.300		
F			7.1			0.280	
I			4.8			0.189	
L		3.3			0.130		
Z	0.44		1.60	0.017		0.063	

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